506179924 07/30/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEUNG KYUN KIM	07/17/2020
YUN JIN SUNG	07/17/2020
BONG-SANG LEE	07/17/2020
HONG RYEOL JEON	07/17/2020

RECEIVING PARTY DATA

Name:	CTC BIO, INC.	
Street Address:	6F, 296 JUNGDAE-RO, SONGPA-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	05724	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16966200

CORRESPONDENCE DATA

Fax Number: (703)997-4905

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ATTORNEY DOCKET NUMBER:	0393.0001-US
NAME OF SUBMITTER:	SHULING LAU WILLIAMS
SIGNATURE:	/Shuling Lau Williams/
DATE SIGNED:	07/30/2020

Total Attachments: 3

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PATENT REEL: 053363 FRAME: 0119

ASSIGNMENT

WHEREAS, I/WE, the below named inventor(s), (hereinafter referred to as Assignor(s)), have made an invention entitled:

CAPSULE FILLING APPARATUS

for which the non-provisional, U.S. Application No. 16/966,200 was filed on 30 July 2020 as a U.S. National Phase application of International Application PCT/KR2018/012364 (International filing date 18 October 2018); and

WHEREAS, CTC BIO, INC., a company whose post office address is 6F, 296 Jungdaero, Songpa-gu, Seoul 05724, Republic of Korea (hereinafter referred to as Assignee), is
desirous of securing the entire right, title, and interest in and to this invention in the United States
of America, in and to all applications for patents filed in the United States of America on this
invention, and in and to all Letters Patent to be issued for this invention in the United States of
America;

NOW THEREFORE, be it known that for good and valuable consideration, the receipt of which from Assignee is hereby acknowledged, I/We as Assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to the above-referenced invention and the above-referenced applications, and all divisions, and continuations thereof, and all Letters Patent of the United States of America that might be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all extensions, renewals, and reissues thereof:

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that might be necessary or desirable to perfect the title to this invention in Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths, and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States of America, it being understood that any expense incident to the execution of such papers shall be borne by Assignee, its successors, and assigns.

PATENT REEL: 053363 FRAME: 0120 AND I/WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND I/WE HEREBY authorize and request my/our agents. MH2 Technology Law Group LLP, whose address is 1951 Kidwell Drive, Suite 310, Tysons Corner, VA 22182, to insert hereon any identification necessary or desirable for recordation of this document, including the filing date and application number of said application when known.

IN WITNESS WHEREOF the Assignee has signed this Assignment and acknowledges receipt of all rights conveyed by this Assignment.

By: C1	IC BIO, INC.,
Ву:	<u>- 9/12</u>
Name:	Hong Rycol JEON
Title:	President
Date:	July 17, 2020

IN TESTIMONY WHEREOF, I have hereunto set my hand:

Date: July 17, 2	2020	Name of Inventor:	Seung Kyun KIM
Date: <u>July 17, 2</u>	020	Name of Inventor:	心 Yun Jin SUNG
Date: <u>July 17, 2</u>	020	Name of Inventor:	* Bong-Sang LEE
Date: <u>July 17, 2</u> 6	020	Name of Inventor:	Hong Rycol JEON

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RECORDED: 07/30/2020